Docket No.: L8462.03103

FORM PTO-1595 (Modified) 04 - 25 - 2003 (Rev. 03-01) 04 - 004 - 25 - 2003 (Modified) 04 - 25 - 2003 (Modified) (Rev. 03-01) 04 - 25 - 2003 (Modified) (Mod				
OMB No. 0651-0027 (exp.5/31/2002) P08/REV03				
1 ab settings	· · · · · · · · · · · · · · · · · · ·			
To the Honorable Commissioner  1. Name of conveying party(ies):  Mitsuaki HAYASHI Shuji NAKAYA Makoto KOJIMA  10243 1333  10243 1333	Name and address of receiving party(ies):  Name: Matsushita Electric Industrial Co., Ltd.  Internal Address:			
Additional names(s) of conveying party(ies)	uniternal Address.			
3. Nature of conveyance:				
	Street Address: 1006, Oaza Kadoma-shi, Osaka			
☐ Security Agreement ☐ Change of Name	571-0050, JAPAN			
☐ Other	City: State: ZIP:			
Execution Date: April 4, 2003	Additional name(s) & address(es) attached?   Yes   No			
<ul> <li>4. Application number(s) or patent numbers(s):</li> <li>If this document is being filed together with a new application</li> <li>A. Patent Application No.(s)</li> </ul>	B. Patent No.(s)			
Additional numbers atta	ched? ☐ Yes ☒ No			
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1			
Name: James E. Ledbetter, Esq.	7. Total fee (37 CFR 3.41):\$ 40.00			
Internal Address: Registration No. 28,732 STEVENS, DAVIS, MILLER & MOSHER, LLP	Enclosed - Any excess or insufficiency should be credited or debited to deposit account			
L8462.03103	☐ Authorized to be charged to deposit account			
Street Address: 1615 L Street, N.W., Suite 850	8. Deposit account number:			
	19-4375			
City: Washington State: DC ZIP: 20036	(Attach duplicate copy of this page if paying by deposit account)			
	USE THIS SPACE			
of the original document	April 18, 2003			
Name of Person Signing  Total number of pages including cover s	Signature Date			

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hington, D.C. 20231
REEL: 013985 FRAME: 0667

## ASSIGNMENT OF PATENT APPLICATION

	(1)	Mitsuaki HAYASHI					
	(2) (3)	Shuji NAKAYA Makoto KOJIMA					
	(4)						
	(5)						
		In consideration of the sum of one dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned, the undersigned agree(s) to assign, and hereby does assign, transfer and set over to					
	(6)	MATSUSHITA ELE	ECTRIC INDUSTR	IAL CO., LTD.			
	(6a) (7)	of 1006, Oaza Kadoma-shi, Osaka 571-0050 JAPAN					
		of	THE THE STATE OF T				
	(hereinat		signee) the entire righ	nts, title and interest for the U			
	(8) Letters P	atent which may be gran	in the invention, ited therefor, known a	and all applications for pater as	nt and any		
	(9)	Semiconductor Mer	nory Device				
				(Case No	)		
	for which the Unite	h the undersigned has (ha ed States of America or,	ave) executed on ever if not on even date, th	n date herewith an applicationen has executed	on for patent in		
	(10)	on		or has already filed			
	(11)	U.S. appln. Serial No.		, filed on			
	assignee	at the time the invention	was made.	of assignment of this invent			
continuing or divis	ional app	ned agree(s) to execute all lications thereof and also ecessary or expedient.	papers necessary in co to execute separate ass	onnection with the application signments in connection with	and any such applications		
2) The declared concerning	undersign ig this app	ed agree(s) to execute all	r division thereof and	onnection with any interference to cooperate with the Assigne	e which may be in every way		
3) The	undersign	ed agree(s) to execute all	papers and documents	and perform any act which n	nay be necessary		
in connection with agreements.	claims or	provisions of the Internat	tional Convention for I	Protection of Industrial Prope	rty or similar		
4) The	undersign	ed_agree(s) to perform all	affirmative acts which	n may be necessary to obtain a	a grant of a valid		
United States pater 5) The	undersign	ed hereby authorize(s) an	d request(s) the Comm	nissioner of Patents to issue ar	ny and all Letters		
Patent of the Unite	d States r	esulting from said applica	tion or any division or	divisions or continuing appli- nat he has (they have) full righ	cations thereof to		
entire interest here				will not execute, any agreeme			
herewith.	undersign	ed hereby grant(s) the firm	n of STEVENS, DAV	IS, MILLER & MOSHER, L.	L.P. the nower		
to insert on this ass	ignment :	any further identification s	which may be necessar	ry or desirable to comply with	the rules of the		
		for recordation of this doc Lexecuted by the undersig		posite the undersigned signatu	are(s).		
		Signature of Inventor					
Date April 4,	2003	Signature of Inventor	(2) Lhuji Rak	eyastii keya ziina	(Seal) (Seal)		
Date April 4.	2003	Signature of Inventor	(3) Mahoto K	ginsti	(Seal)		
Date		Signature of Inventor Signature of Inventor	(5)		(Seal) (Seal)		
This assi Counsel if outside	gnment s the U.S.	hould preferably be sign- A.—If neither, then it sh	ed before: (a) a Notar ould be signed before	y Public if within the U.S.A e at least two witnesses who	., or (b) a U.S. also sign here:		
Date April 4,	2003	Signature of Witness	Suma Kona	10 15	Seal)		
Date April 4, 2	003	Signature of Witness	Misoru Hate	to (5	Seal)		

**RECORDED: 04/18/2003** 

**PATENT REEL: 013985 FRAME: 0668**